



1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP AND BOTTOM SIDES SMD.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. INSTALL TURRETS AS SHOWN.

APPROVALS		TITLE: TOP ASSEMBLY DRAWING, ISOLATED MONOLITHIC FLYBACK CONVERTER	
PCB DES.	MI	SIZE	IC NO
APP. ENG.	Zhongming Y.	N/A	LT3575EFE
			REV
			2
			DEMO CIRCUIT 1643A
SCALE: NONE	FILENAME: 1643A-1.PCB		
		SHT 1 of 2	